

1 A Three-quadrant triacs high commutation Rev. 04 — 4 February 2008

Product data sheet

Product profile 1.

1.1 General description

Passivated, guaranteed commutation triacs in a plastic package. The 'sensitive gate' E and ER series are intended for interfacing with low power drivers, including microcontrollers. The high commutation B series are designed to commutate the full RMS current at the maximum junction temperature without the aid of a snubber.

1.2 Features

Suitable for interfacing with low power Reverse pinning option (ER type) drivers, including microcontrollers

1.3 Applications

Motor controls

1.4 Quick reference data

- I_{TSM} ≤ 12.5 A
- $I_{T(RMS)} \le 1 A$
- V_{DRM} ≤ 600 V (BTA201-600B/E)
- V_{DRM} ≤ 800 V (BTA201-800B/E/ER)
- Solenoid drivers
 - I_{GT} \leq 50 mA (BTA201-600B/800B)
 - I_{GT} \leq 10 mA (BTA201-600E/800E/ER)
 - I_{GT} ≥ 5 mA (BTA201-600B/800B)
 - I_{GT} \ge 1 mA (BTA201-600E/800E/ER)

Pinning information 2.

Table 1. Pin	ning		
Pin	Description	Simplified outline	Graphic symbol
B and E series	i i		
1	main terminal 2 (T2)		N 1
2	gate (G)		T2-T1
3	main terminal 1 (T1)		`G sym051
ER series			
1	main terminal 1 (T1)		
2	gate (G)	321	
3	main terminal 2 (T2)	SOT54 (TO-92)	



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3. Ordering information

Table 2. Orde	ring inform	ation					
Type number	Package	Package					
	Name	Description	Version				
BTA201-600B	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54				
BTA201-600E							
BTA201-800B							
BTA201-800E							
BTA201-800ER							

4. Limiting values

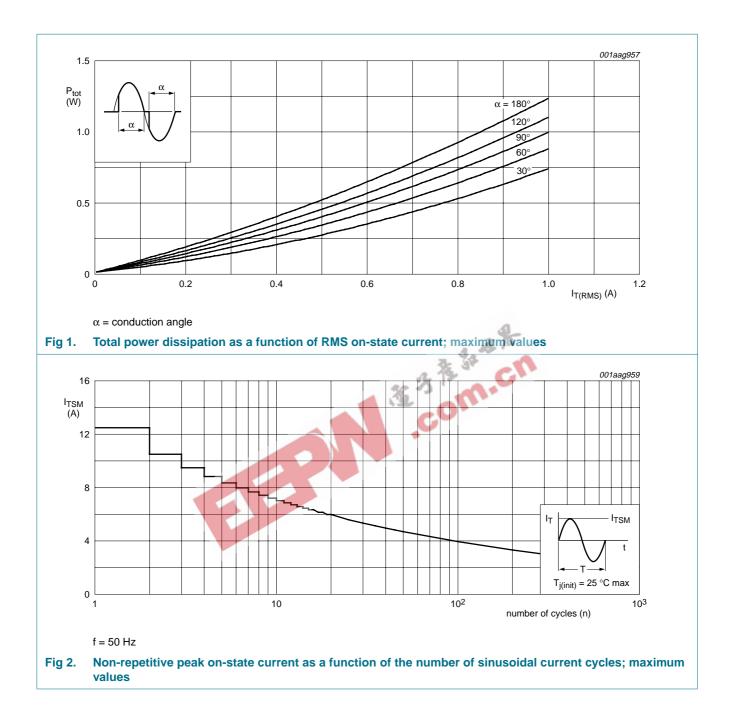
Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit			
V _{DRM}	ParameterConditionsMinMaxUnitrepetitive peak off-state voltageBTA201-600B11 -600VBTA201-600E11 -600VBTA201-800B-800V							
		BTA201-600B	1 -	600	V			
		BTA201-600E	<u>1]</u> _	600	V			
		BTA201-800B	-	800	V			
		BTA201-800E	-	800	V			
		BTA201-800ER	-	800	V			
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{lead} \le 54.3 \text{ °C}$; see Figure 4 and 5	-	1	A			
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>						
		t = 20 ms	-	12.5	А			
		t = 16.7 ms	-	13.7	А			
l ² t	l ² t for fusing	t _p = 10 ms	-	0.78	A ² s			
dl _T /dt	rate of rise of on-state current	$I_{TM} = 1.5 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs			
I _{GM}	peak gate current		-	2	А			
P _{GM}	peak gate power		-	5	W			
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W			
T _{stg}	storage temperature		-40	+150	°C			
T _j	junction temperature		-	125	°C			

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/µs.

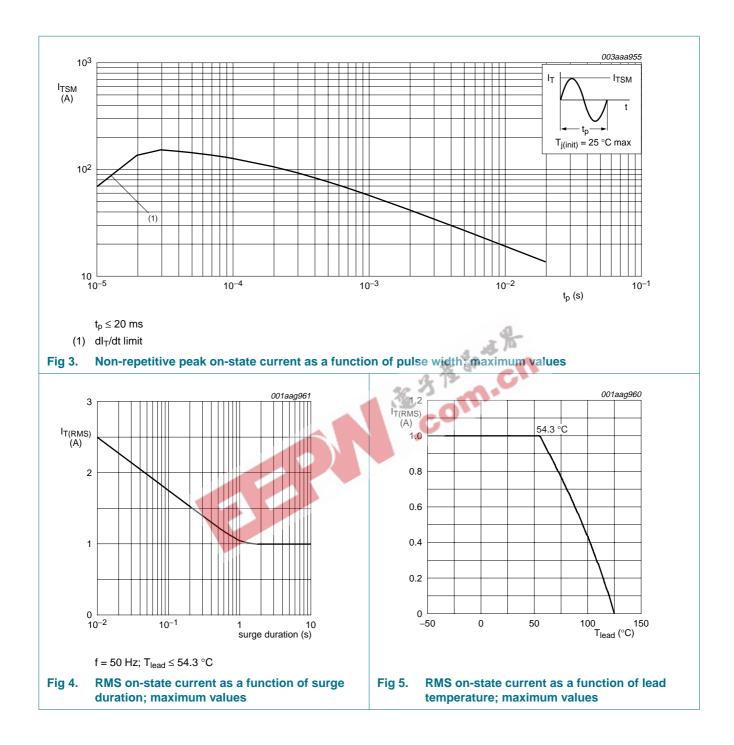
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BTA201 series B, E and ER

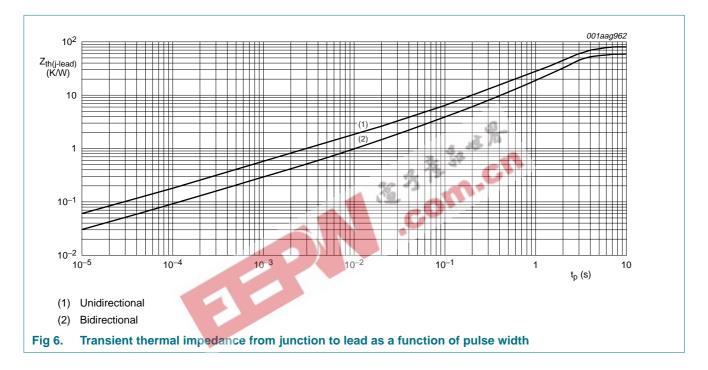
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	full cycle; see Figure 6	-	-	60	K/W
		half cycle; see Figure 6	-	-	80	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W



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6. Static characteristics

Table 5.Static characteristics

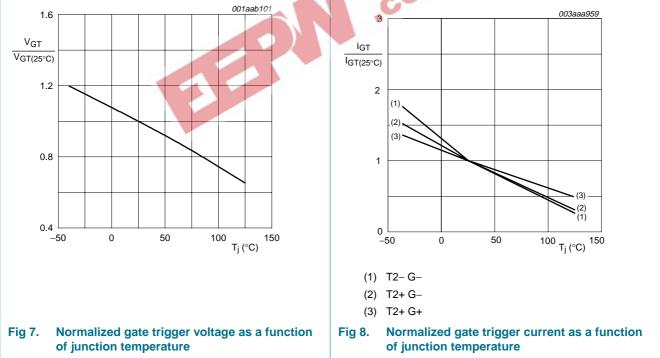
 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER			Unit
			Min	Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$							
		T2+ G+	5	-	50	1	-	10	mA
		T2+ G–	5	-	50	1	-	10	mA
		T2– G–	5	-	50	1	-	10	mA
۱L	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{100000000000000000000000000000000$							
		T2+ G+	-	-	30	-	-	12	mA
		T2+ G-	-	-	50	-	-	20	mA
		T2– G–	-	-	30	-	-	12	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{\text{Figure } 11}$	-	1.4	30	-	-	12	mA
VT	on-state voltage	I _T = 1.4 A; see <u>Figure 9</u>	- 36	1.2	1.5	-	1.2	1.5	V
V _{GT}	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 7}}$	37	0.7	1.5	-	0.7	1.5	V
		$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \text{ °C}$	0.2	0.3	-	0.2	0.3	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 °C$	S	0.1	0.5	-	0.1	0.5	mA

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7. Dynamic characteristics

Table 6. Symbol	Dynamic character	Conditions	_	BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER		
			Min	Тур	Max	Min	Тур	Max	_
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)};$ $T_j = 125 °C;$ exponential waveform; gate open circuit	1000	-	-	600	-	-	V/μs
dl _{com} /dt	rate of change of commutating current	V_{DM} = 400 V; T _j = 125 °C; dV _{com} /dt = 20 V/µs; gate open circuit	12	-	-	2.5	-	-	A/ms
		V_{DM} = 400 V; T _j = 125 °C; dV _{com} /dt = 10 V/µs; gate open circuit	16	-	-	3.5	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A}; \\ V_D &= V_{DRM(max)}; \\ I_G &= 0.1 \text{ A}; \\ dI_G/dt &= 5 \text{ A}/\mu \text{s} \end{split}$	-	2	34-35 Y	-	2	-	μs
1.6		001aab101	36	, CO	w.			003aaa959	

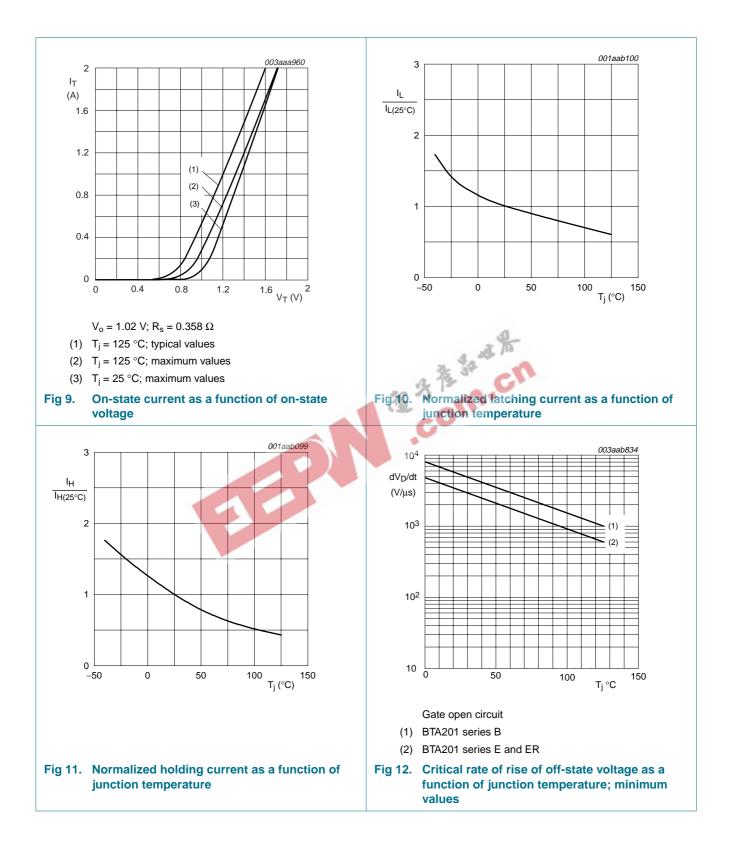


BTA201_SER_B_E_ER_4

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8. Package outline

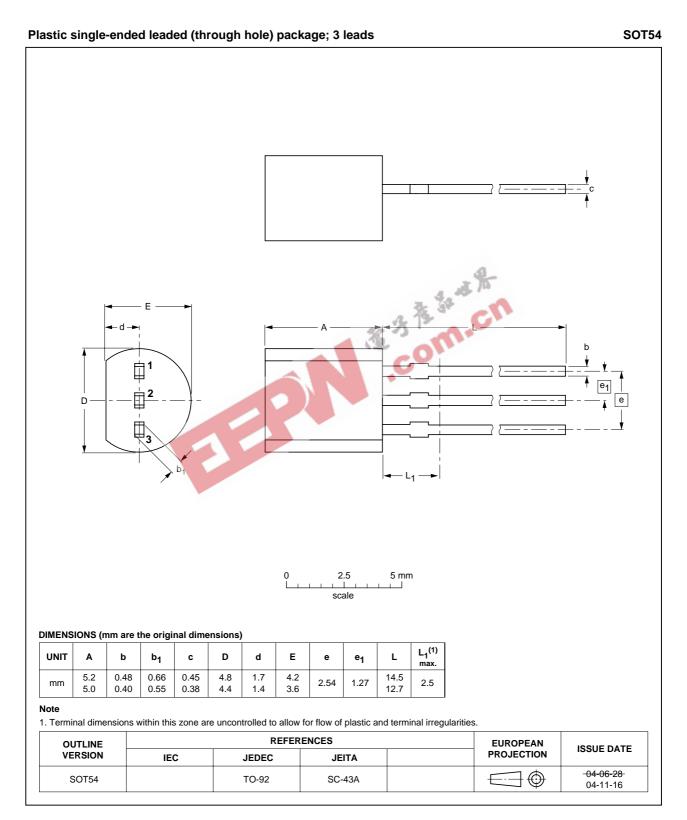


Fig 13. Package outline SOT54 (TO-92)

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9. Revision history

Table 7. Revision histor	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA201_SER_B_E_ER_4	20080204	Product data sheet	-	BTA201_SER_B_E_ER_3
Modifications:	• Figure 3: C	Changed figure.		
	 Section 1.4 	4 "Quick reference data" or	page 1: Updated wit	h minimum I _{GT} values added.
	 Table 3 "Li 	miting values" on page 2: l	² t condition, t _p ; symbo	l update.
	 Table 5 "St 	atic characteristics" on page	<mark>je 6</mark> : Minimum I _{GT} val	ues added.
BTA201_SER_B_E_ER_3	20070910	Product data sheet	-	BTA201_SER_B_E_ER_2
Modifications:		t of this data sheet has bee of NXP Semiconductors.	n redesigned to com	bly with the new identity
	 Legal texts 	s have been adapted to the	new company name	where appropriate.
	 Descriptive 	e titles have been corrected	I.	
	 Table 3 "Li 	miting values" on page 2: c	ll _T /dt uprated.	
	 Table 6 "D 	ynamic characteristics" on	page 7: dV _D /dt uprate	d.
		'Critical rate of rise of off-st values" on page 8: graph up		tion of junction temperature;
BTA201_SER_B_E_ER_2	20060113	Product data sheet	2 12 6	BTA201_SER_B_E_ER_1
Modifications:	• Figure 4: F	igure note corrected		
	 Table 6 "D 	ynamic characteristics" on	page 7: Units correcte	ed
	 Figure 12: 	Figure title corrected		
BTA201_SER_B_E_ER_1 (9397 750 15154)	20050825	Product data sheet	-	-
	E			

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10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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	Definitions

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